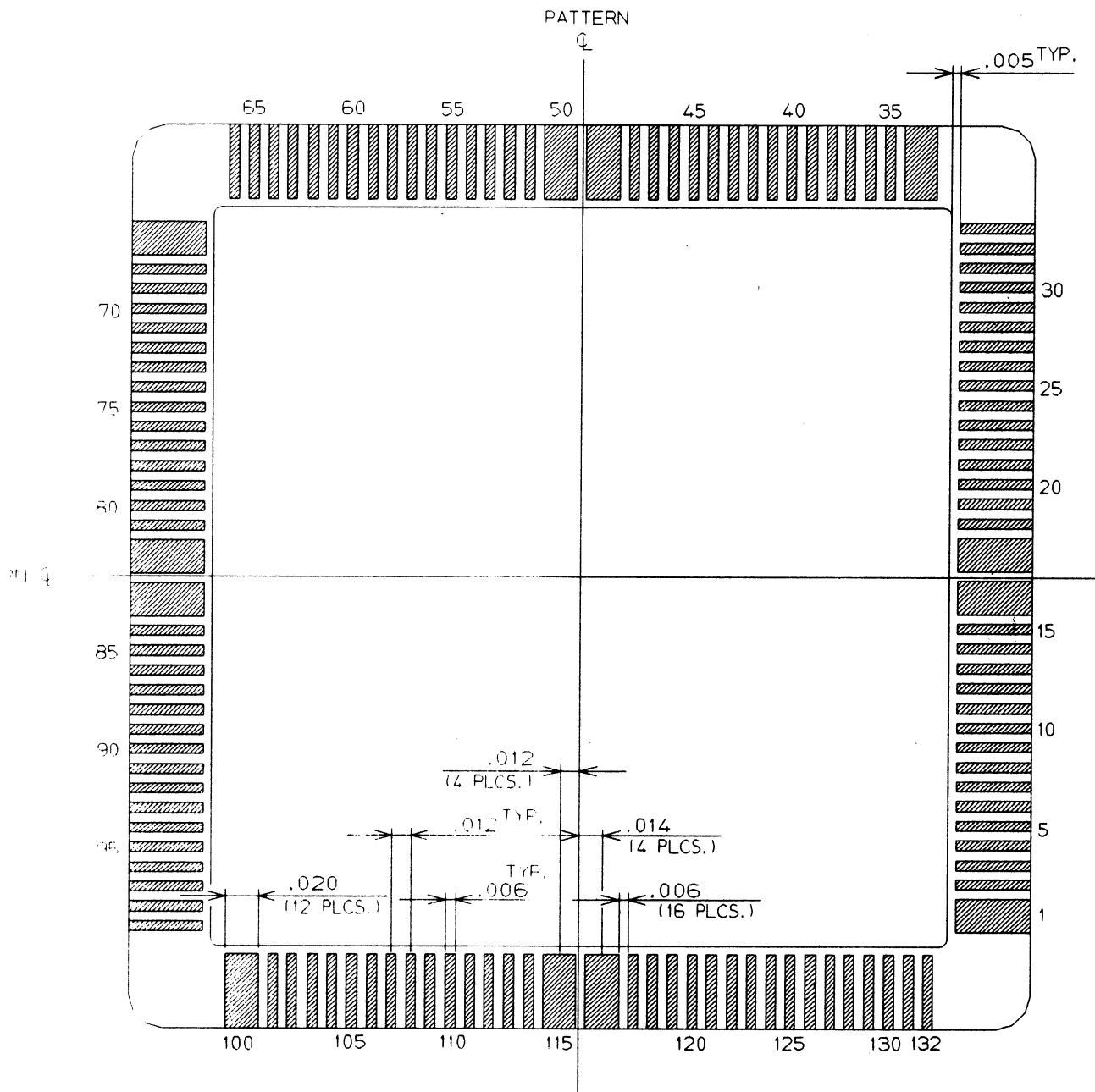


- NOTES :
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE METALLIZED.
 4. SEAL RING TO BE FLOATING FROM ANY PINS.
 5. DIE ATTACH AREA TO BE FLOATING FROM ANY PINS.
 6. LEAD RESISTANCE:
B/F NO. 1,16,17,34,49,50,67,82,83,100,115,116 ----- 0.2Ω MAX.
THE OTHERS ----- 1.5Ω MAX.

SSM CPG13208

MODIFICATION	△ CORRECT (NOTE 5)	FEB. 4 '92	S.N	A.F.T.A	K.M	NAME	TOLERANCE	PB132N560-1				S=0
	△ REDRAWN	APR. 16 '91	K.IM	A.F.T.A	M.K	132 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	DRAWN	CHECKED	APPROVED	DATE	D=0
	△ CHANGED : .050 X .018 ± .008 → .050 X .026	MAY. 09 '91	M.K			SCALE 5/1	MATERIAL	S.K	M.S		SEP. 20 '83	
	△ CHANGED : .170 → .205 ± .010. ADDED : STAND OFF PIN	FEB. 15 '84	M.K	M.S		AS INDICATED	±.005					
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION		DRAWING NO.		SHEET	
						KYOTO JAPAN	KD-P83560-D				1/3	




BONDING PATTERN

MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					132 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	S.K	M.S		SEP.20.'83
					SCALE 20/1	MATERIAL				
						THIRD ANGLE PROJECTION				
	△ REDRAWN	APR.16.'91	K. IM	A.F.T.A	M.K					
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION		DRAWING NO.	SHEET
						KYOTO JAPAN	KD-P83560-D		2/3	

WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.
1	C3	27	L2	53	P9	79	J14	105	B11	131	A1
2	B1	28	K3	54	N9	80	H14	106	A11	132	B2
3	C2	29	N1	55	M9	81	H13	107	C10		
4	D3	30	M2	56	P10	82	H12	108	B10		
5	C1	31	L3	57	P11	83	G12	109	A10		
6	D2	32	P1	58	N10	84	G13	110	C9		
7	D1	33	N2	59	P12	85	G14	111	B9		
8	E3	34	M3	60	N11	86	F14	112	A9		
9	E2	35	P2	61	M10	87	F13	113	A8		
10	E1	36	N3	62	P13	88	F12	114	B8		
11	F3	37	M4	63	N12	89	E14	115	C8		
12	F2	38	P3	64	M11	90	D14	116	C7		
13	F1	39	N4	65	P14	91	E13	117	B7		
14	G1	40	P4	66	N13	92	C14	118	A7		
15	G2	41	M5	67	M12	93	D13	119	A6		
16	G3	42	N5	68	N14	94	E12	120	B6		
17	H3	43	P5	69	M13	95	B14	121	C6		
18	H2	44	M6	70	L12	96	C13	122	A5		
19	H1	45	N6	71	M14	97	D12	123	A4		
20	J1	46	P6	72	L13	98	A14	124	B5		
21	J2	47	P7	73	L14	99	B13	125	A3		
22	J3	48	N7	74	K12	100	C12	126	B4		
23	K1	49	M7	75	K13	101	A13	127	C5		
24	L1	50	M8	76	K14	102	B12	128	A2		
25	K2	51	N8	77	J12	103	C11	129	B3		
26	M1	52	P8	78	J13	104	A12	130	C4		

S/R	NC
D/A	NC

MODIFICATION								NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
								132 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	S.K	M.S		SEP.20.'83
								SCALE	MATERIAL				
	△ REDRAWN								THIRD ANGLE PROJECTION				
	CHANGED	APR.16.'91	K.IM	A.F.T.A	M.K				KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO.			SHEET
		DATE	DRAWN	CHECKED	APPROVED					KD-P83560-D			3/3